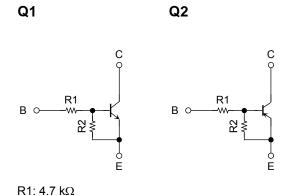
TOSHIBA Transistor Silicon NPN · PNP Epitaxial Type (PCT process) (Bias Resistor Built-in Transistor)

# **RN4981FS**

Switching, Inverter Circuit, Interface Circuit and Driver Circuit Applications.

- Two devices are incorporated into a fine pitch small mold (6-pin) package.
- Incorporating a bias resistor into a transistor reduces parts count. Reducing the parts count enables the manufacture of ever more compact equipment and lowers assembly cost.

#### **Equivalent Circuit and Bias Resistor Values**



0.1±0.05 0.8±0.05 0.1±0.05 0.15±0.05 6 0.7±0.05 35 Q 5 OHO. 35 1±0.05 +0.02 0 \$ 1.EMIITTER1 (E1) 2.BASE1 (B1) 3 COLLECTOR2. (C2) 4.EMIITTER2 (E2) 5.BASE2 (B2) 6.COLLECTOR1 fS6 (C1) JEDEC \_\_\_\_ JEITA TOSHIBA 2-1F1D

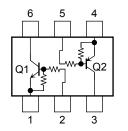
1.0±0.05

Weight: 0.001g (typ.)

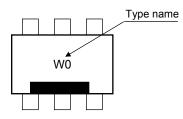
(Q1, Q2 common)

R2: 4.7 kΩ

#### Equivalent Circuit (top view)



#### Marking



Unit: mm

#### Absolute Maximum Ratings (Ta = 25°C) (Q1)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CBO</sub>	20	V
Collector-emitter voltage	V <sub>CEO</sub>	20	V
Emitter-base voltage	V <sub>EBO</sub>	10	V
Collector current	Ι <sub>C</sub>	50	mA

### Absolute Maximum Ratings (Ta = 25°C) (Q2)

Characteristics	Symbol	Rating	Unit
Collector-base voltage	V <sub>CBO</sub>	-20	V
Collector-emitter voltage	V <sub>CEO</sub>	-20	V
Emitter-base voltage	V <sub>EBO</sub>	-10	V
Collector current	Ι <sub>C</sub>	-50	mA

#### Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 common)

Characteristics	Symbol	Rating	Unit
Collector power dissipation	P <sub>C</sub> (Note 1)	50	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Total rating

## Electrical Characteristics (Ta = 25°C) (Q1)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB}=20~V,~I_{E}=0$	_	_	100	nA
	ICEO	$V_{CE}=20~V,~I_B=0$	_	_	500	
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB}=10~V,~I_C=0$	0.89	_	1.33	mA
DC current gain	h <sub>FE</sub>	$V_{CE} = 5 \text{ V}, \text{ I}_{C} = 10 \text{ mA}$	30	_	—	
Collector-emitter saturation voltage	V <sub>CE (sat)</sub>	$I_{C} = 5 \text{ mA}, I_{B} = 0.25 \text{ mA}$	_	_	0.15	V
Input voltage (ON)	V <sub>I (ON)</sub>	$V_{CE} = 0.2 \text{ V}, I_{C} = 5 \text{ mA}$	1.0	_	2.0	V
Input voltage (OFF)	VI (OFF)	$V_{CE} = 5 \text{ V}, \text{ I}_{C} = 0.1 \text{ mA}$	0.8	_	1.5	V
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		1.2		pF

### Electrical Characteristics (Ta =25°C) (Q2)

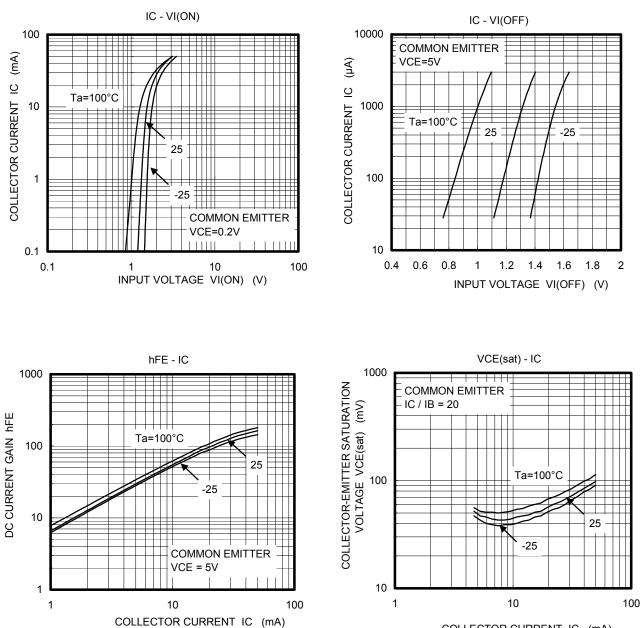
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	$V_{CB}=-20~V,~I_{E}=0$			-100	nA
	I <sub>CEO</sub>	$V_{CE} = -20 \text{ V}, \text{ I}_{B} = 0$	_	_	-500	ПА
Emitter cut-off current	I <sub>EBO</sub>	$V_{EB} = -10 \text{ V}, I_C = 0$	-0.89	_	-1.33	mA
DC current gain	h <sub>FE</sub>	$V_{CE} = -5 \text{ V}, \text{ I}_{C} = -10 \text{ mA}$	30	_		
Collector-emitter saturation voltage	V <sub>CE (sat)</sub>	$I_{C} = -5 \text{ mA}, I_{B} = -0.25 \text{ mA}$	_	_	-0.15	V
Input voltage (ON)	V <sub>I (ON)</sub>	$V_{CE} = -0.2$ V, $I_C = -5$ mA	-1.0	_	-2.0	V
Input voltage (OFF)	V <sub>I (OFF)</sub>	$V_{CE} = -5 \text{ V}, \text{ I}_{C} = -0.1 \text{ mA}$	-0.8		-1.5	V
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$	_	1.2		pF

#### Electrical Characteristics (Ta = 25°C) (Q1, Q2 common)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input resistor	R1	—	3.76	4.7	5.64	kΩ
Resistor ratio	R1/R2	—	0.8	1.0	1.2	

# <u>TOSHIBA</u>

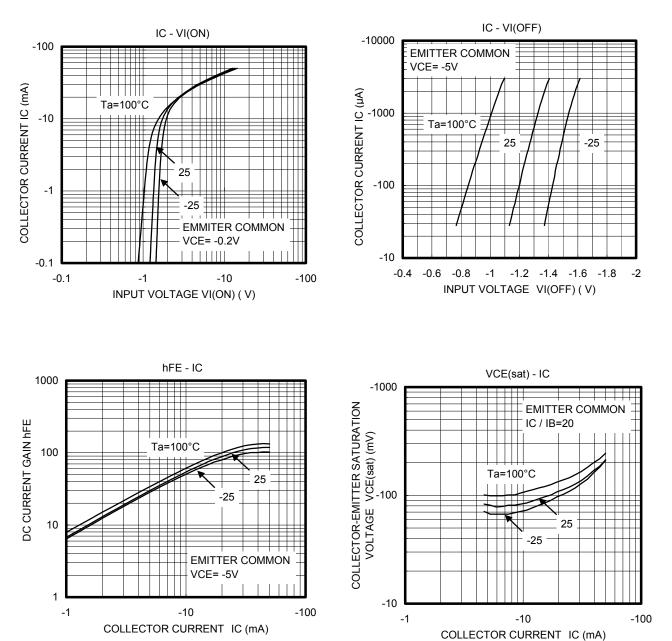
Q1



COLLECTOR CURRENT IC (mA)

# <u>TOSHIBA</u>

Q2



#### **Handling Precaution**

When handling individual devices (which are not yet mounted on a circuit board), be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

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